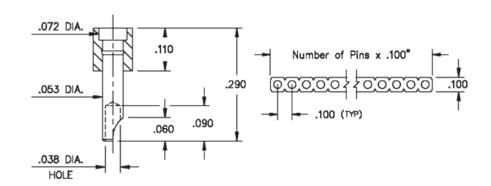
# **DATA SHEET**

Product Number: 330-10-164-00-240000



Description:
Interconnect Header
Spring-Loaded Target Connector
Single Row
Plating Code:
10
Shell Plating:

10  $\mu^{\text{\tiny{II}}}$  Gold over 100  $\mu^{\text{\tiny{II}}}$  Nickel

# Of Pins	Mill-Max Part Number	RoHS Compliant
64	330-10-164-00-240000	RoHS 2002/96/EC

## LOOSE PIN:

Pin Used: 3024 (Brass Alloy)

BRASS ALLOY (UNS C36000) per ASTM B 16

#### **Properties of BRASS ALLOY:**

- Chemical composition: Cu 61.5%, Zn 35.4%, Pb 3.1%†
- Hardness as machined: 80-90 Rockwell B
- Density: .307 lbs/in3
- Electrical conductivity: 26% IACS\*
- Melting point: 900°C/885°C (liquidus/solidus)

†(3 to 4% lead is used to permit "free machining" and is permitted by EC Directive 2002/95Annex 6; so all pin materials are RoHS compliant)

\*International Annealed Copper Standard, i.e. as a % of pure copper.

### **INSULATOR INFORMATION:**

#### PCT Polyester, (Thermx CG933, black)

High Temperature

#### **Properties of PCT Polyester:**

- Brand: Thermx • Grade: CG-933

- Rated voltage: 100 VRMS/150 VDC
  Insulation resistance: 10,000 Megaohms min.
  Material Heat Deflection Temp (per ASTM D 648): 529°F (276°C) @ 66 psi
  Dielectric strength: 1000 VRMS min. (700 VRMS min. for series 117 Shrink DIP)

Note: Materials above 446°F (230°C) are considered suitable for "eutectic" reflow soldering, above  $500^{\circ}F$  (260°C) for "lead-free" reflow soldering.